

SPECIFICATIONS

Rated Current:3.0AMP

Contact Resistance:20mΩ Max

Withstand Voltage:1000V AC/DC

Insulation Resistance:1000MΩ Min

Operation Temperature:-40°C to +105°C

Contact Material:Copper Alloy

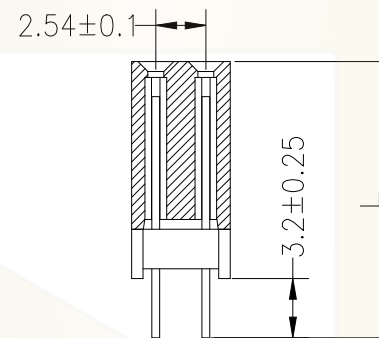
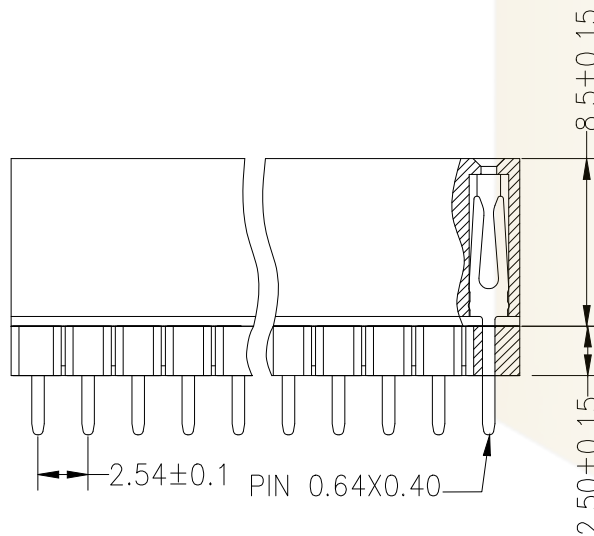
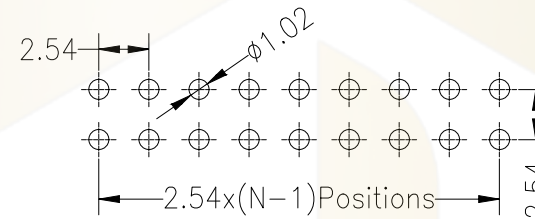
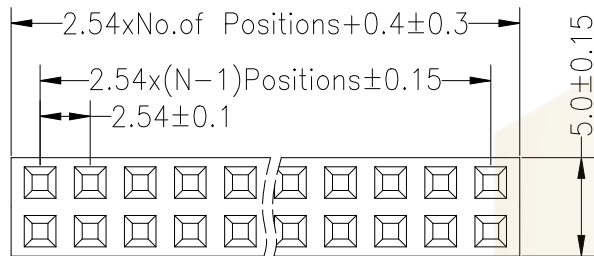
Contact Plating:Au or Sn Over Ni

Insulator Material:Polyester(UL94V-0)

Standard: PA6T

Max.Processing Temp: 260°C±5°C 5S

Recommended P.C.B Layout(Top Side) (PCB BOARD TOLERANCE±0.05)



Ordering Information

PM 254 - * - N - Z - * - ** - AP

No. of Rows
1=Single Row
2=Dual Row

No. of Pins
2=40Pin

Type
Z=直排
N=弯排
S=交排

Length
(Plastic)
(mm)

Contact Plating
G0:Gold Flash
G1:1u" Gold
G2:3u" Gold
G3:5u" Gold
G4:10u" Gold
G5:15u" Gold
G6:30u" Gold
S0:Gold Flash/Tin
S1:Tin

Plastic
(加塑垫)



			GENERAL TOLERANCE	制 图 DRAWING	深圳市华灿天禄电子有限公司 ShenzhenhuacantianluELECTRONICS CO., LTD			
			DIM TOL	审 核 CHECK				
			X. X ±0.30	批 准 APPROVAL	产品名称 TITLE	2.54双排 直排母 加塑垫	版 本 REV.	A
			X. XX ±0.20	比 例 SCALE	产品料号 PART NO.	PM254-2-N-Z-8.5-XX-AP(L14.2)	单 位 UNITS	mm
1	初版发行		X. XXX ±0.10	投 影 Projection		材 料 MATERIAL	页 次 SHEET	1/1
序号 No.	变更内容 MODIFY CONTENT	日期 MODIFY DATE	Angle ±3.0°					